CM600DU-24NFH

HIGH POWER SWITCHING USE

CM600DU-24NFH

- I_C 600A
- V_{CES} 1200V
- Insulated Type
- 2-elements in a pack

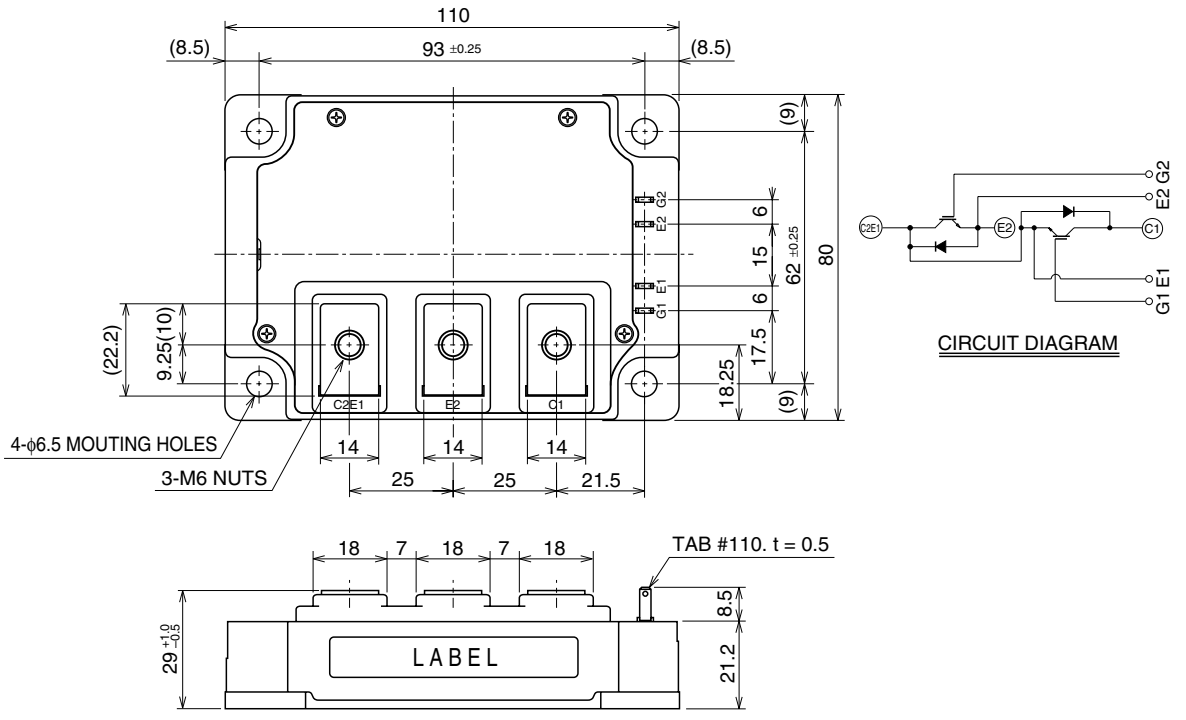
APPLICATION

High frequency switching use (30kHz to 60kHz).

Gradient amplifier, Induction heating, power supply, etc.

OUTLINE DRAWING & CIRCUIT DIAGRAM

Dimensions in mm



MITSUBISHI ELECTRIC

MAXIMUM RATINGS (Tj = 25°C, unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
V_{CES}	Collector-emitter voltage	G-E Short	1200	V
V_{GES}	Gate-emitter voltage	C-E Short	±20	V
I_C	Collector current	Operation (Note 2)	600	A
I_{CM}		Pulse (Note 2)	1200	A
I_E (Note 1)	Emitter current	Operation (Note 2)	600	A
I_{EM} (Note 1)		Pulse (Note 2)	1200	A
P_C (Note 3)	Maximum collector dissipation	T_C = 25°C	1500	W
P_C' (Note 3)	Maximum collector dissipation	T_C' = 25°C*4	3670	W
T_j	Junction temperature		–40 ~ +150	°C
T_{stg}	Storage temperature		–40 ~ +125	°C
V_{iso}	Isolation voltage	Terminals to base plate, f = 60Hz, AC 1 minute	2500	Vrms
—	Mounting torque	Main terminals M6 screw	3.5 ~ 4.5	N • m
—		Mounting M6 screw	3.5 ~ 4.5	N • m
—	Weight	Typical value	580	g

ELECTRICAL CHARACTERISTICS (Tj = 25°C, unless otherwise specified)

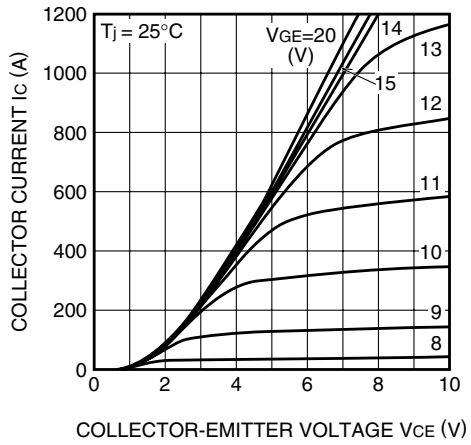
Symbol	Parameter	Test conditions		Limits			Unit
				Min.	Typ.	Max.	
I_{CES}	Collector cutoff current	V_{CE} = V_{CES}, V_{GE} = 0V		—	—	1	mA
$V_{GE(th)}$	Gate-emitter threshold voltage	I_C = 60mA, V_{CE} = 10V		4.5	6	7.5	V
I_{GES}	Gate leakage current	±V_{GE} = V_{GES}, V_{CE} = 0V		—	—	2.0	µA
$V_{CE(sat)}$	Collector-emitter saturation voltage	I_C = 600A, V_{GE} = 15V	T_j = 25°C	—	5.0	6.5	V
			T_j = 125°C	—	5.0	—	
C_{ies}	Input capacitance	V_{CE} = 10V, V_{GE} = 0V		—	—	95	nF
C_{oes}	Output capacitance			—	—	8.0	nF
C_{res}	Reverse transfer capacitance			—	—	1.8	nF
Q_G	Total gate charge	V_{CC} = 600V, I_C = 600A, V_{GE} = 15V		—	2700	—	nC
$t_{d(on)}$	Turn-on delay time	V_{CC} = 600V, I_C = 600A, V_{GE} = ±15V, R_G = 0.52Ω, Inductive load, I_E = 600A		—	—	400	ns
t_r	Turn-on rise time			—	—	120	ns
$t_{d(off)}$	Turn-off delay time			—	—	700	ns
t_f	Turn-off fall time			—	—	150	ns
t_{rr} (Note 1)	Reverse recovery time			—	—	250	ns
Q_{rr} (Note 1)	Reverse recovery charge			—	28	—	µC
V_{EC}(Note 1)	Emitter-collector voltage	I_E = 600A, V_{GE} = 0V		—	—	3.5	V
$R_{th(j-c)Q}$	Thermal resistance*1	IGBT part (1/2 module)		—	—	0.083	K/W
$R_{th(j-c)R}$		FWDi part (1/2 module)		—	—	0.15	K/W
$R_{th(c-f)}$	Contact thermal resistance	Case to heat sink, Thermal compound Applied*2 (1/2 module)		—	0.02	—	K/W
$R_{th(j-c')Q}$	Thermal resistance*4	IGBT part (1/2 module)		—	—	0.034*3	K/W
$R_{th(j-c')R}$		FWDi part (1/2 module)		—	—	0.06*3	K/W
R_G	External gate resistance			0.52	—	5.2	Ω

*1 : Case temperature (T_C) measured point is shown in page OUTLINE DRAWING.
*2 : Typical value is measured by using thermally conductive grease of λ = 0.9[W/(m • K)].
*3 : If you use this value, $R_{th(f-a)}$ should be measured just under the chips.
*4 : Case temperature (T_C') measured point is just under the chips.

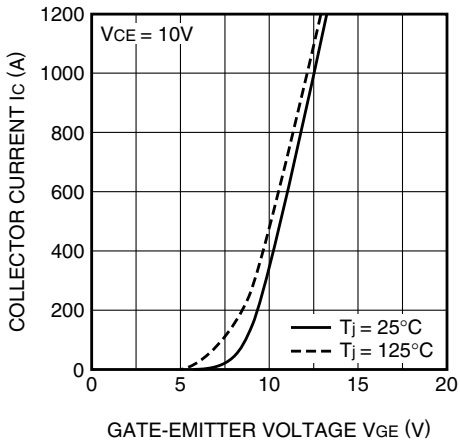
Note 1. I_E, V_{EC}, t_{rr} & Q_{rr} represent characteristics of the anti-parallel, emitter-collector free-wheel diode (FWDi).
2. Pulse width and repetition rate should be such that the device junction temperature (T_j) does not exceed T_{jmax} rating.
3. Junction temperature (T_j) should not increase beyond 150°C.
4. No short circuit capability is designed.

PERFORMANCE CURVES

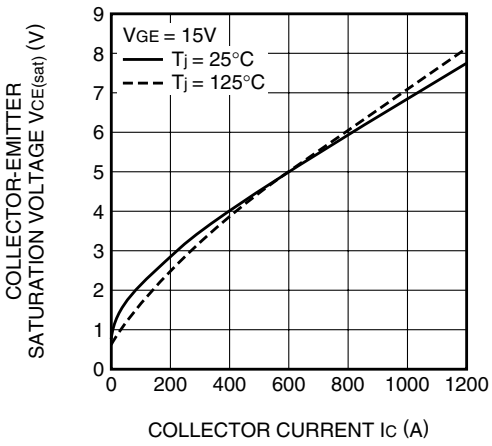
OUTPUT CHARACTERISTICS (TYPICAL)



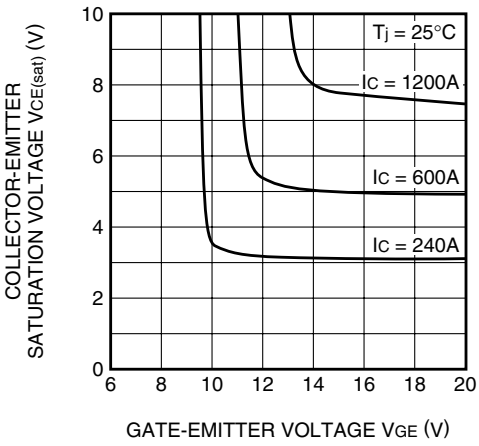
TRANSFER CHARACTERISTICS (TYPICAL)



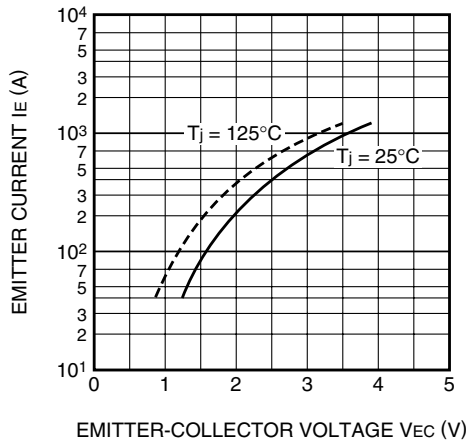
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



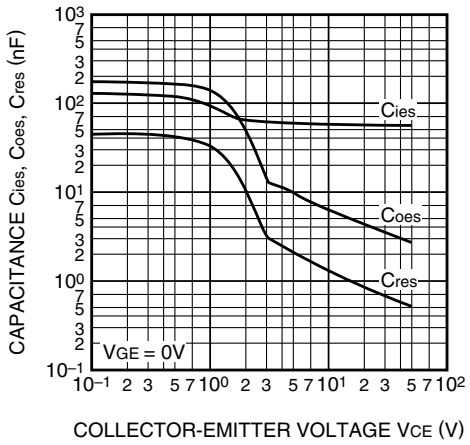
COLLECTOR-EMITTER SATURATION VOLTAGE CHARACTERISTICS (TYPICAL)



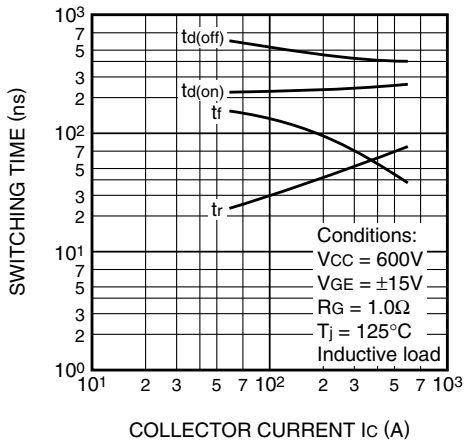
FREE-WHEEL DIODE FORWARD CHARACTERISTICS (TYPICAL)



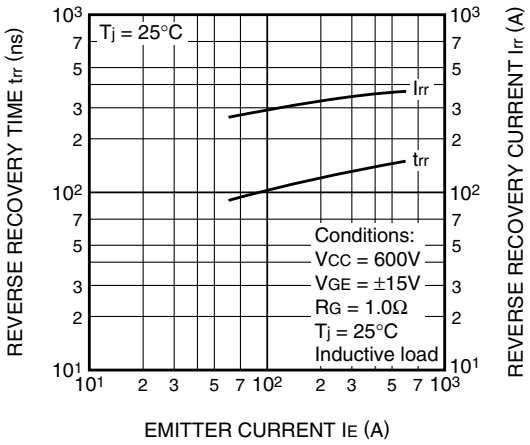
CAPACITANCE CHARACTERISTICS (TYPICAL)



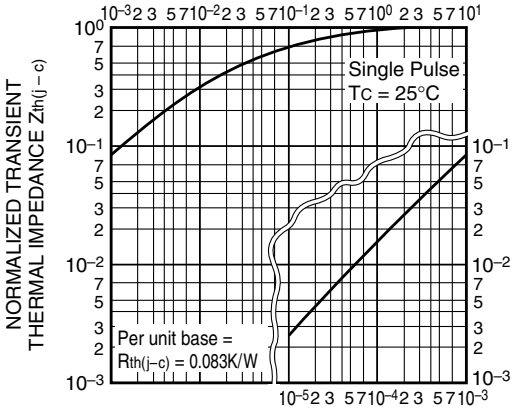
HALF-BRIDGE SWITCHING TIME CHARACTERISTICS (TYPICAL)



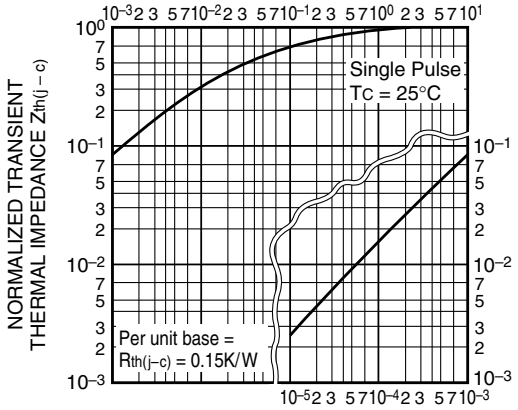
REVERSE RECOVERY CHARACTERISTICS OF FREE-WHEEL DIODE (TYPICAL)



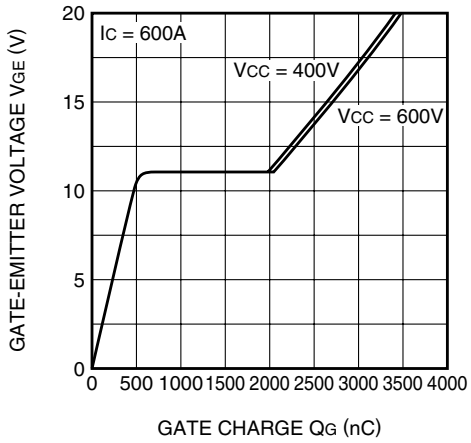
TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (IGBT part)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS (FWDi part)



GATE CHARGE CHARACTERISTICS (TYPICAL)



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